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4717-10500

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COMMENTS

PLEASE SEE THE ATTACHED DRAFT FOR YOUR REVIEW.

In re: Application of: Christophe MALEVILLE et al.

Application No. 10/808,288

Filing Date: March 25, 2004

For: METHOD FOR PREPARING A BONDING

SURFACE OF A SEMICONDUCTOR LAYER OF

A WAFER

Confirmation No. 5090

Group Art Unit: 2812

Attorney Docket No. 4717-10500

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MAR 14 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

In response to the final office action dated December 15, 2005, please enter the following amendments and comments into the file of this application.

No amendments to the claims are presented herewith.

Remarks begin on page 2 of this paper.

No fees are believed to be due with this response. Should any fees be required to process this amendment, however, please charge them to Winston & Strawn LLP Deposit Account No. 50-1814.